

Board Stack Report

| Stack Up | | Layer Stack | | | | | | | |
|----------|--------------------|----------------|---------------|-----------|----------|-----|--------------------|-------------|--------------------|
| Layer | Board Layer Stack | Name | Material | Thickness | Constant | Dk | Coverlay expansion | Orientation | Copper Orientation |
| 1 | Height : 1.59144mm | Top Overlay | | 0mm | | | | | |
| 2 | | Top Solder | Solder Resist | 0.01016mm | 3.5 | 3.5 | 0mm | | |
| 3 | | Top Layer | | 0.03556mm | | | | BodyUp | Above |
| 4 | | Dielectric 1 | FR-4 | 1.5mm | 4.8 | 4.8 | | | |
| 5 | | Bottom Layer | | 0.03556mm | | | | BodyDown | Below |
| 6 | | Bottom Solder | Solder Resist | 0.01016mm | 3.5 | 3.5 | 0mm | | |
| 7 | | Bottom Overlay | | 0mm | | | | | |
| | Height : 1.59144mm | | | | | | | | |